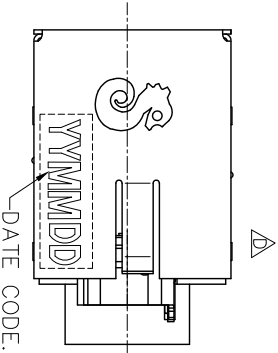
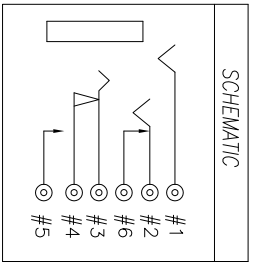
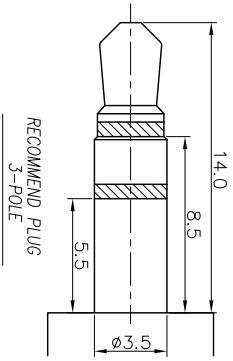


RECOMMEND PCB LAYOUT (TOP VIEW)  
(TOLERANCE: ±0.05)



- SPECIFICATIONS:
- INSULATION RESISTANCE BETWEEN ANY ADJACENT OPEN CIRCUIT TERMINAL SHELL NOT BE LESS THAN 100M $\Omega$  MEASURED BY 500 VDC MEGGER.
  - CONTACT RESISTANCE: 30m $\Omega$  MAX. (200m $\Omega$  MAX:METAL TO EARTH TO SHIELDING)
  - INSULATION VOLTAGE WITHSTAND: 500V AC FOR ONE MINUTE; UNLESS OTHERWISE SPECIFIED. TEST IS TO BE MADE AT 5-35°C IN TEMPERATURE AND 45-85% IN HUMIDITY. BUT,IF ANY VAGUE DATA IS OCCURED ON TEST RESULT, ANOTHER TEST SHALL BE MADE AT 20°C±2°C IN TEMP., 60-70% IN HUMIDITY.
  - LIFE TEST: 5,000 CYCLES MIN. (NON-LOAD)
  - INSERTION FORCE:0.4 - 3kg.
  - WITHDRAWAL FORCE:0.3 - 2kg.
  - AFTER LIFE TEST, CONTACT RESISTANCE: 50m $\Omega$  MAX.
  - AFTER HUMIDITY TEST, INSULATION RESISTANCE: 50M $\Omega$  MIN.
  - MARKING: MARK "S" ON TOP OF CONNECTOR.
  - PACKAGING: TAPE & REEL.
  - TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC
  - GREEN PRODUCT IDENTIFICATION MARK ON JACK:
  - GREEN PRODUCT IDENTIFICATION LABEL ON PACKAGING:
  - FOR LEAD-FREE PROCESS.

REV.	ECN NO.	OR DESCRIPTION	REVISED	DATE
B	ECN NO.S090726		LILI	2009.07.21
C	ECN NO.S110320		Cerry	2011.03.28
D	ECN NO.C130115	UPDATE DRAWING	ZJK	2013.06.04
E	ECN NO.C130206	MODIFY BODY	ZLS	2014.4.1

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
A	BODY	1	HIGH TEMP THERMOPLASTIC UL 94V-0	PINK (701C)
B	EARTH	1	COPPER ALLOY 0.2t	
C	TIP SPRING	1	PHOSPHOR BRONZE 0.25t	Ag 20u"Min OVER Ni 60u"Min.
D	SHUNT TERMINAL-A	1	BRASS 0.25t	
E	RING SPRING	1	PHOSPHOR BRONZE 0.2t	Sn 120u" On SOLDER; ALL OVER Ni 50u"
F	BREAK TERMINAL	1	PHOSPHOR BRONZE 0.2t	GOLD FLASH ON CONTACT AREA.
G	TRANSFER TERMINAL	1	PHOSPHOR BRONZE 0.2t	Ni 60u" MIN.
H	SHIELDING	1	PHOSPHOR BRONZE 0.2t	

DECIMALS:	ANGLES:
X. :±0.5	X. :±2°
XX. :±0.3	X.X :±1°
XXX. :±0.2	
X.XXX :±0.1	

TITLE	PART NO.	UNIT	SHEET	REV.
3.5Ø PHONE JACK	2SI-S351-008	mm	1 OF 1	E

CUSTOMER COPY

单击下面可查看定价，库存，交付和生命周期等信息

[>>信音](#)